Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, IrDA, LINbus, MMC/SD/SDIO, QSPI, SmartCard, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	80
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b820f2048gq100-b

3.4.2 Internal and External Oscillators

The EFM32GG11 supports two crystal oscillators and fully integrates five RC oscillators, listed below.

- A high frequency crystal oscillator (HFXO) with integrated load capacitors, tunable in small steps, provides a precise timing reference for the MCU. Crystal frequencies in the range from 4 to 50 MHz are supported. An external clock source such as a TCXO can also be applied to the HFXO input for improved accuracy over temperature.
- A 32.768 kHz crystal oscillator (LFXO) provides an accurate timing reference for low energy modes.
- An integrated high frequency RC oscillator (HFRCO) is available for the MCU system. The HFRCO employs fast startup at minimal energy consumption combined with a wide frequency range. When crystal accuracy is not required, it can be operated in free-running mode at a number of factory-calibrated frequencies. A digital phase-locked loop (DPLL) feature allows the HFRCO to achieve higher accuracy and stability by referencing other available clock sources such as LFXO and HFXO.
- An integrated auxilliary high frequency RC oscillator (AUXHFRCO) is available for timing the general-purpose ADC and the Serial Wire Viewer port with a wide frequency range.
- An integrated auxilliary high frequency RC oscillator (USHFRCO) is available for timing the USB, SDIO and QSPI peripherals. The USHFRCO can be syncronized to the host's USB clock to allow the USB to operate in device mode without the additional cost of an external crystal.
- An integrated low frequency 32.768 kHz RC oscillator (LFRCO) can be used as a timing reference in low energy modes, when crystal accuracy is not required.
- An integrated ultra-low frequency 1 kHz RC oscillator (ULFRCO) is available to provide a timing reference at the lowest energy consumption in low energy modes.

3.5 Counters/Timers and PWM

3.5.1 Timer/Counter (TIMER)

TIMER peripherals keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each TIMER is a 16-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the TIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit TIMER_0 only.

3.5.2 Wide Timer/Counter (WTIMER)

WTIMER peripherals function just as TIMER peripherals, but are 32 bits wide. They keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each WTIMER is a 32-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the WTIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit WTIMER_0 only.

3.5.3 Real Time Counter and Calendar (RTCC)

The Real Time Counter and Calendar (RTCC) is a 32-bit counter providing timekeeping in all energy modes. The RTCC includes a Binary Coded Decimal (BCD) calendar mode for easy time and date keeping. The RTCC can be clocked by any of the on-board oscillators with the exception of the AUXHFRCO, and it is capable of providing system wake-up at user defined instances. The RTCC includes 128 bytes of general purpose data retention, allowing easy and convenient data storage in all energy modes down to EM4H.

3.5.4 Low Energy Timer (LETIMER)

The unique LETIMER is a 16-bit timer that is available in energy mode EM2 Deep Sleep in addition to EM1 Sleep and EM0 Active. This allows it to be used for timing and output generation when most of the device is powered down, allowing simple tasks to be performed while the power consumption of the system is kept at an absolute minimum. The LETIMER can be used to output a variety of waveforms with minimal software intervention. The LETIMER is connected to the Real Time Counter and Calendar (RTCC), and can be configured to start counting on compare matches from the RTCC.

3.5.5 Ultra Low Power Wake-up Timer (CRYOTIMER)

The CRYOTIMER is a 32-bit counter that is capable of running in all energy modes. It can be clocked by either the 32.768 kHz crystal oscillator (LFXO), the 32.768 kHz RC oscillator (LFRCO), or the 1 kHz RC oscillator (ULFRCO). It can provide periodic Wakeup events and PRS signals which can be used to wake up peripherals from any energy mode. The CRYOTIMER provides a wide range of interrupt periods, facilitating flexible ultra-low energy operation.

3.11 Memory Map

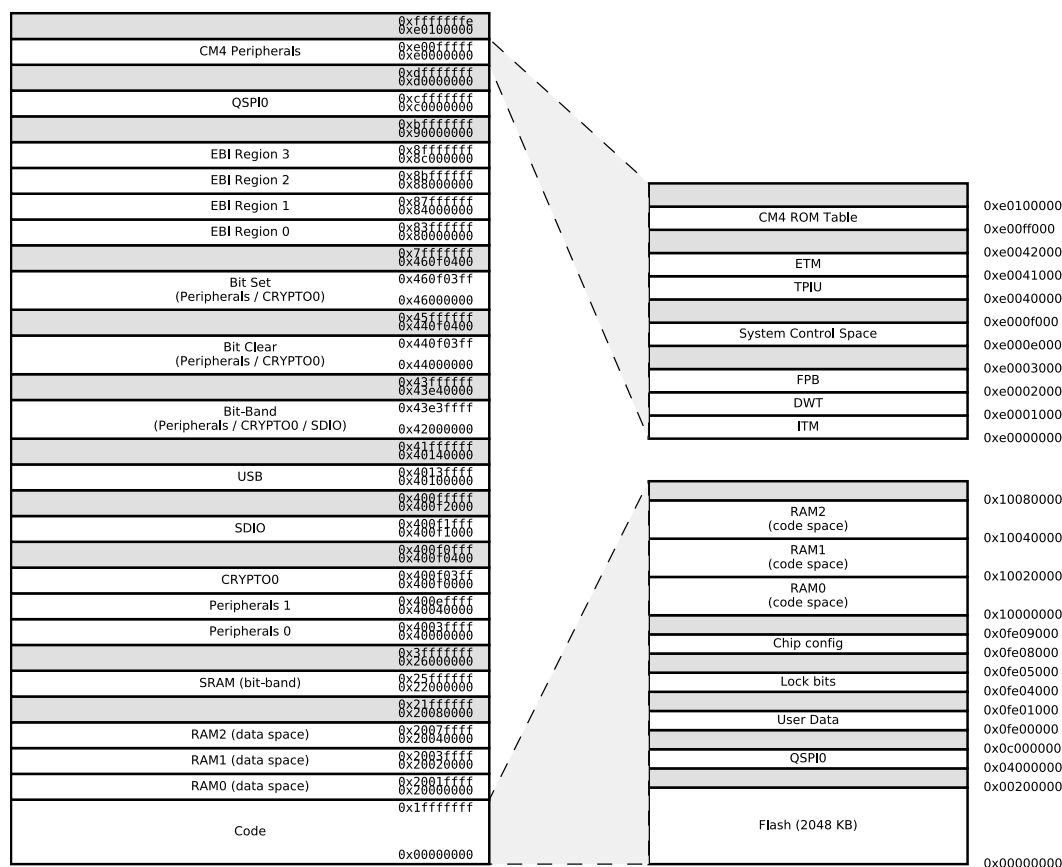The EFM32GG11 memory map is shown in the figures below. RAM and flash sizes are for the largest memory configuration.

Figure 3.2. EFM32GG11 Memory Map — Core Peripherals and Code Space

4.1.5 5V Regulator

V_{VREGI} = 5 V, V_{VREGO} = 3.3 V, C_{VREGI} = 10 µF, C_{VREGO} = 4.7 µF, unless otherwise specified.

Table 4.5. 5V Regulator

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
VREGI or VBUS input voltage range	V_{VREGI}	Regulating output	2.7	—	5.5	V
		Bypass mode enabled	2.7	—	3.8	V
VREGO output voltage	V_{VREGO}	Regulating output, 3.3 V setting	3.1	3.3	3.5	V
		EM4S open-loop output, I_{OUT} < 100 µA	1.8	—	3.8	V
Voltage output step size	V_{VREGO_SS}		—	0.1	—	V
Resistance in Bypass Mode	R_{BYP}	Bypass mode enabled	—	1.2	TBD	Ω
Output current	I_{OUT}	EM0 or EM1, V_{VREGI} > V_{VREGO} + 0.6 V	—	—	200	mA
		EM0 or EM1, V_{VREGI} > V_{VREGO} + 0.3 V	—	—	100	mA
		EM2, EM3, or EM4H, V_{VREGI} > V_{VREGO} + 0.6 V	—	—	2	mA
		EM2, EM3, or EM4H, V_{VREGI} > V_{VREGO} + 0.3 V	—	—	0.5	mA
		EM4S	—	—	20	µA
Load regulation	LR_{VREGO}	EM0 or EM1	—	0.10	—	mV/mA
		EM2, EM3, or EM4H	—	2.5	—	mV/mA
DC power supply rejection	PSR_{DC}		—	40	—	dB
VREGI or VBUS bypass capacitance	C_{VREGI}		—	10	—	µF
VREGO bypass capacitance	C_{VREGO}		1	4.7	10	µF
Supply current consumption	I_{VREGI}	EM0 or EM1, No load	—	29	—	µA
		EM2, EM3, or EM4H, No load	—	270	—	nA
		EM4S, No load	—	70	—	nA
VREGI and VBUS detection high threshold	V_{DET_H}		TBD	1.18	—	V
VREGI and VBUS detection low threshold	V_{DET_L}		—	1.12	TBD	V
Current monitor transfer ratio	$IMON_{XF}$	Translation of current through VREGO path to voltage at ADC input	—	0.35	—	mA/mV

4.1.6 Backup Supply Domain

Table 4.6. Backup Supply Domain

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Backup supply voltage range	V_{BU_VIN}		1.8	—	3.8	V
PWRRES resistor	R_{PWRRES}	EMU_BUCTRL_PWRRES = RES0	3400	3900	4400	Ω
		EMU_BUCTRL_PWRRES = RES1	1450	1800	2150	Ω
		EMU_BUCTRL_PWRRES = RES2	1000	1350	1700	Ω
		EMU_BUCTRL_PWRRES = RES3	525	815	1100	Ω
Output impedance between BU_VIN and BU_VOUT [2]	R_{BU_VOUT}	EMU_BUCTRL_VOUTRES = STRONG	35	110	185	Ω
		EMU_BUCTRL_VOUTRES = MED	475	775	1075	Ω
		EMU_BUCTRL_VOUTRES = WEAK	5600	6500	7400	Ω
Supply current	I_{BU_VIN}	BU_VIN not powering backup domain	—	11	TBD	nA
		BU_VIN powering backup domain[1]	—	550	TBD	nA

Note:

1. Additional current required by backup circuitry when backup is active. Includes supply current of backup switches and backup regulator. Does not include supply current required for backed-up circuitry.
2. BU_VOUT and BU_STAT signals are not available in all package configurations. Check the device pinout for availability.

4.1.10 Oscillators

4.1.10.1 Low-Frequency Crystal Oscillator (LFXO)

Table 4.12. Low-Frequency Crystal Oscillator (LFXO)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Crystal frequency	f_{LFXO}		—	32.768	—	kHz
Supported crystal equivalent series resistance (ESR)	ESR_{LFXO}		—	—	70	kΩ
Supported range of crystal load capacitance [1]	C_{LFXO_CL}		6	—	18	pF
On-chip tuning cap range [2]	C_{LFXO_T}	On each of LFXTAL_N and LFXTAL_P pins	8	—	40	pF
On-chip tuning cap step size	SS_{LFXO}		—	0.25	—	pF
Current consumption after startup [3]	I_{LFXO}	ESR = 70 kOhm, C_L = 7 pF, GAIN[4] = 2, AGC[4] = 1	—	273	—	nA
Start- up time	t_{LFXO}	ESR = 70 kOhm, C_L = 7 pF, GAIN[4] = 2	—	308	—	ms

Note:

1. Total load capacitance as seen by the crystal.
2. The effective load capacitance seen by the crystal will be C_{LFXO_T} /2. This is because each XTAL pin has a tuning cap and the two caps will be seen in series by the crystal.
3. Block is supplied by AVDD if ANASW = 0, or DVDD if ANASW=1 in EMU_PWRCTRL register.
4. In CMU_LFXOCTRL register.

4.1.12 General-Purpose I/O (GPIO)

Table 4.20. General-Purpose I/O (GPIO)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input low voltage	V_{IL}	GPIO pins	—	—	IOVDD*0.3	V
Input high voltage	V_{IH}	GPIO pins	IOVDD*0.7	—	—	V
Output high voltage relative to IOVDD	V_{OH}	Sourcing 3 mA, IOVDD ≥ 3 V, DRIVESTRENGTH[1] = WEAK	IOVDD*0.8	—	—	V
		Sourcing 1.2 mA, IOVDD ≥ 1.62 V, DRIVESTRENGTH[1] = WEAK	IOVDD*0.6	—	—	V
		Sourcing 20 mA, IOVDD ≥ 3 V, DRIVESTRENGTH[1] = STRONG	IOVDD*0.8	—	—	V
		Sourcing 8 mA, IOVDD ≥ 1.62 V, DRIVESTRENGTH[1] = STRONG	IOVDD*0.6	—	—	V
Output low voltage relative to IOVDD	V_{OL}	Sinking 3 mA, IOVDD ≥ 3 V, DRIVESTRENGTH[1] = WEAK	—	—	IOVDD*0.2	V
		Sinking 1.2 mA, IOVDD ≥ 1.62 V, DRIVESTRENGTH[1] = WEAK	—	—	IOVDD*0.4	V
		Sinking 20 mA, IOVDD ≥ 3 V, DRIVESTRENGTH[1] = STRONG	—	—	IOVDD*0.2	V
		Sinking 8 mA, IOVDD ≥ 1.62 V, DRIVESTRENGTH[1] = STRONG	—	—	IOVDD*0.4	V
Input leakage current	I_{IOLEAK}	All GPIO except LFXO pins, GPIO ≤ IOVDD, T ≤ 85 °C	—	0.1	TBD	nA
		LFXO Pins, GPIO ≤ IOVDD, T ≤ 85 °C	—	0.1	TBD	nA
		All GPIO except LFXO pins, GPIO ≤ IOVDD, T > 85 °C	—	—	TBD	nA
		LFXO Pins, GPIO ≤ IOVDD, T > 85 °C	—	—	TBD	nA
Input leakage current on 5VTOL pads above IOVDD	$I_{5VTOLLEAK}$	IOVDD < GPIO ≤ IOVDD + 2 V	—	3.3	TBD	µA
I/O pin pull-up/pull-down resistor	R_{PUD}		TBD	40	TBD	kΩ
Pulse width of pulses removed by the glitch suppression filter	$t_{IOGLITCH}$		15	25	35	ns

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VBUS	A13	USB VBUS signal and auxiliary input to 5 V regulator.	PF11	A14	GPIO (5V)
PF10	A15	GPIO (5V)	PF0	A16	GPIO (5V)
PA0	B1	GPIO	PD11	B2	GPIO
PD10	B3	GPIO	PD9	B4	GPIO
PF9	B5	GPIO	PF8	B6	GPIO
PF7	B7	GPIO	PF6	B8	GPIO
PI11	B9	GPIO (5V)	PI8	B10	GPIO (5V)
PF5	B11	GPIO	PF13	B12	GPIO (5V)
PF3	B13	GPIO	PF2	B14	GPIO
PF1	B15	GPIO (5V)	VREGO	B16	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs
PA1	C1	GPIO	PD12	C2	GPIO
PD14	C3	GPIO (5V)	PD13	C4	GPIO (5V)
PI15	C5	GPIO (5V)	PI14	C6	GPIO (5V)
PI13	C7	GPIO (5V)	PI12	C8	GPIO (5V)
PI10	C9	GPIO (5V)	PI7	C10	GPIO (5V)
PF15	C11	GPIO (5V)	PF12	C12	GPIO
PF4	C13	GPIO	PC15	C14	GPIO (5V)
PC14	C15	GPIO (5V)	VREGI	C16	Input to 5 V regulator.
PA2	D1	GPIO	PG0	D2	GPIO (5V)
PD15	D3	GPIO (5V)	PC13	D14	GPIO (5V)
PC12	D15	GPIO (5V)	PC11	D16	GPIO (5V)
PA3	E1	GPIO	PG2	E2	GPIO (5V)
PG1	E3	GPIO (5V)	PC10	E14	GPIO (5V)
PC9	E15	GPIO (5V)	PC8	E16	GPIO (5V)
PA4	F1	GPIO	PG4	F2	GPIO (5V)
PG3	F3	GPIO (5V)	IOVDD2	F6 G6	Digital IO power supply 2.

Pin Name	Pin(s)	Description		Pin Name	Pin(s)	Description
PE8	B4	GPIO		PD11	B5	GPIO
PF8	B6	GPIO		PF6	B7	GPIO
PF3	B8	GPIO		PE5	B9	GPIO
PC12	B10	GPIO (5V)		PC13	B11	GPIO (5V)
PA1	C1	GPIO		PA0	C2	GPIO
PE10	C3	GPIO		PD13	C4	GPIO (5V)
PD12	C5	GPIO		PF9	C6	GPIO
VSS	C7 D4 F9 G3 G9 H6 K4 K7 K10 L7	Ground		PF2	C8	GPIO
PE6	C9	GPIO		PC10	C10	GPIO (5V)
PC11	C11	GPIO (5V)		PA3	D1	GPIO
PA2	D2	GPIO		PB15	D3	GPIO (5V)
IOVDD1	D5	Digital IO power supply 1.		PD9	D6	GPIO
IOVDD0	D7 G8 H7 L4	Digital IO power supply 0.		PF1	D8	GPIO (5V)
PE7	D9	GPIO		PC8	D10	GPIO (5V)
PC9	D11	GPIO (5V)		PA6	E1	GPIO
PA5	E2	GPIO		PA4	E3	GPIO
PB0	E4	GPIO		PF0	E8	GPIO (5V)
PE0	E9	GPIO (5V)		PE1	E10	GPIO (5V)
PE3	E11	GPIO		PB1	F1	GPIO
PB2	F2	GPIO		PB3	F3	GPIO
PB4	F4	GPIO		DVDD	F8	Digital power supply.
PE2	F10	GPIO		DECOUPLE	F11	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PB5	G1	GPIO		PB6	G2	GPIO
IOVDD2	G4	Digital IO power supply 2.		PC6	G10	GPIO
PC7	G11	GPIO		PC0	H1	GPIO (5V)
PC2	H2	GPIO (5V)		PD14	H3	GPIO (5V)
PA7	H4	GPIO		PA8	H5	GPIO
PD8	H8	GPIO		PD5	H9	GPIO
PD6	H10	GPIO		PD7	H11	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC1	J1	GPIO (5V)	PC3	J2	GPIO (5V)
PD15	J3	GPIO (5V)	PA12	J4	GPIO (5V)
PA9	J5	GPIO	PA10	J6	GPIO
PB9	J7	GPIO (5V)	PB10	J8	GPIO (5V)
PD2	J9	GPIO (5V)	PD3	J10	GPIO
PD4	J11	GPIO	PB7	K1	GPIO
PC4	K2	GPIO	PA13	K3	GPIO (5V)
PA11	K5	GPIO	RESETn	K6	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
AVDD	K8 K9 L10	Analog power supply.	PD1	K11	GPIO
PB8	L1	GPIO	PC5	L2	GPIO
PA14	L3	GPIO	PB11	L5	GPIO
PB12	L6	GPIO	PB13	L8	GPIO
PB14	L9	GPIO	PD0	L11	GPIO (5V)

Note:

1. GPIO with 5V tolerance are indicated by (5V).

2. The pins PD13, PD14, and PD15 will not be 5V tolerant on all future devices. In order to preserve upgrade options with full hardware compatibility, do not use these pins with 5V domains.

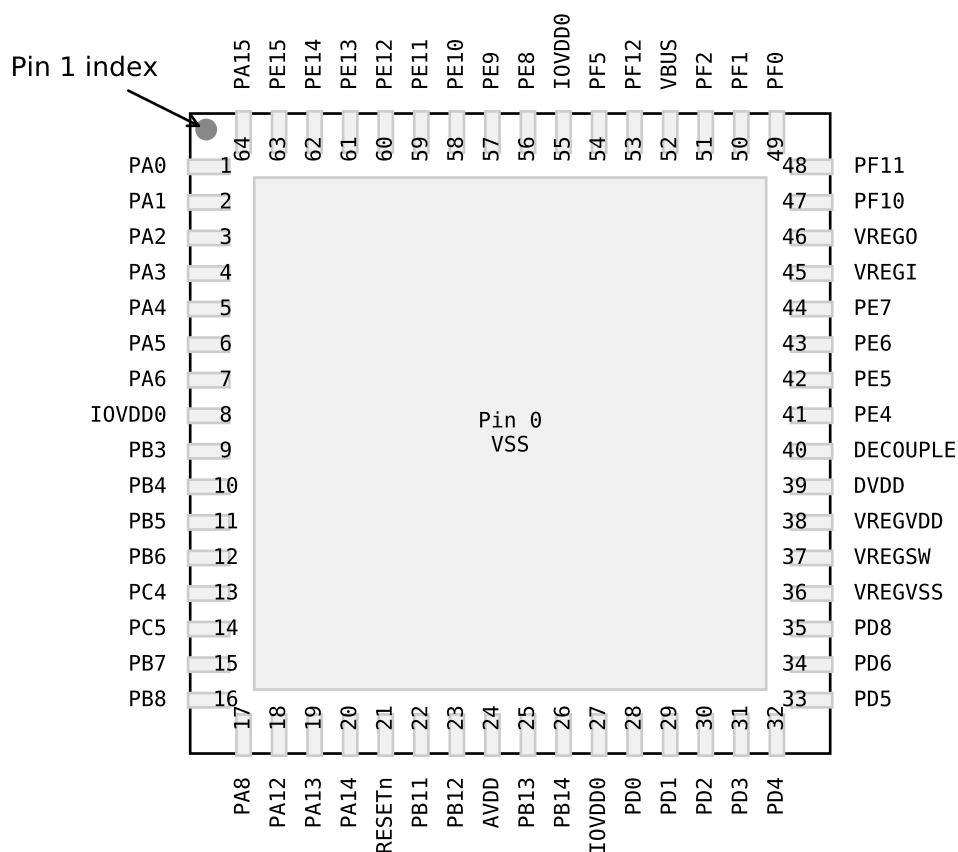**5.16 EFM32GG11B8xx in QFN64 Device Pinout**

Figure 5.16. EFM32GG11B8xx in QFN64 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see 5.20 GPIO Functionality Table or 5.21 Alternate Functionality Overview.

Table 5.16. EFM32GG11B8xx in QFN64 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
VSS	0	Ground	PA0	1	GPIO
PA1	2	GPIO	PA2	3	GPIO
PA3	4	GPIO	PA4	5	GPIO
PA5	6	GPIO	PA6	7	GPIO
IOVDD0	8 27 55	Digital IO power supply 0.	PB3	9	GPIO
PB4	10	GPIO	PB5	11	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PB6	12	GPIO	PC4	13	GPIO
PC5	14	GPIO	PB7	15	GPIO
PB8	16	GPIO	PA12	17	GPIO (5V)
PA13	18	GPIO (5V)	PA14	19	GPIO
RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.	PB11	21	GPIO
PB12	22	GPIO	AVDD	23 27	Analog power supply.
PB13	24	GPIO	PB14	25	GPIO
PD0	28	GPIO (5V)	PD1	29	GPIO
PD2	30	GPIO (5V)	PD3	31	GPIO
PD4	32	GPIO	PD5	33	GPIO
PD6	34	GPIO	PD7	35	GPIO
PD8	36	GPIO	PC6	37	GPIO
PC7	38	GPIO	DVDD	39	Digital power supply.
DECOUPLE	40	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.	PE4	41	GPIO
PE5	42	GPIO	PE6	43	GPIO
PE7	44	GPIO	VREGI	45	Input to 5 V regulator.
VREGO	46	Decoupling for 5 V regulator and regulator output. Power for USB PHY in USB-enabled OPNs	PF10	47	GPIO (5V)
PF11	48	GPIO (5V)	PF0	49	GPIO (5V)
PF1	50	GPIO (5V)	PF2	51	GPIO
VBUS	52	USB VBUS signal and auxiliary input to 5 V regulator.	PF12	53	GPIO
PF5	54	GPIO	PE8	56	GPIO
PE9	57	GPIO	PE10	58	GPIO
PE11	59	GPIO	PE12	60	GPIO
PE13	61	GPIO	PE14	62	GPIO
PE15	63	GPIO	PA15	64	GPIO

Note:
1. GPIO with 5V tolerance are indicated by (5V).

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PF7	BUSCY BUSDX LCD_SEG25	EBI_BL1 #0 EBI_BL1 #4 EBI_BL1 #5 EBI_DCLK #1	TIM0_CC1 #1 TIM4_CC1 #4	ETH_RMIITXD0 #1 US2_RX #4 QSPI0_CS0 #0 ETH_MIIRXER #2 US1_RX #3 U0_RX #0	PRS_CH23 #2
PF6	BUSDY BUSCX LCD_SEG24	EBI_BL0 #0 EBI_BL0 #4 EBI_BL0 #5 EBI_CSTFT #1	TIM0_CC0 #1 TIM4_CC0 #4 WTIM3_CC2 #5	ETH_RMIITXD1 #1 US2_TX #4 QSPI0_SCLK #0 US1_TX #3 U0_TX #0	PRS_CH22 #2
PI11				US4_RTS #3	
PI8		EBI_A13 #2	TIM1_CC2 #7 TIM4_CC0 #3	US4_CLK #3	
PF5	BUSCY BUSDX LCD_SEG3	EBI_REn #0 EBI_REn #5 EBI_A27 #1	TIM0_CDTI2 #2 TIM1_CC3 #6 TIM4_CC0 #2	US2_CS #5 I2C2_SCL #0 USB_VBUSEN	PRS_CH2 #1 DBG_TDI
PF13	BUSCY BUSDX		TIM1_CC0 #6 TIM4_CC0 #1 TIM5_CC1 #7 WTIM3_CC0 #7	US5_CLK #2 I2C2_SDA #4	
PF3	BUSCY BUSDX LCD_SEG1	EBI_ALE #0	TIM4_CC0 #0 TIM0_CDTI0 #2 TIM1_CC1 #5	CAN1_TX #1 US1_CTS #2 I2C2_SCL #5	CMU_CLK1 #4 PRS_CH0 #1 ETM_TD3 #1
PF2	BUSDY BUSCX LCD_SEG0	EBI_ARDY #0 EBI_A26 #1	TIM0_CC2 #4 TIM1_CC0 #5 TIM2_CC0 #3	US2_CLK #5 CAN0_TX #1 US1_TX #5 U0_RX #5 LEU0_TX #4 I2C1_SCL #4	CMU_CLK0 #4 PRS_CH0 #3 ACMP1_O #0 DBG_TDO DBG_SWO #0 GPIO_EM4WU4
PF1	BUSCY BUSDX	EBI_A25 #1	TIM0_CC1 #4 WTIM0_CC2 #4 LE-TIM0_OUT1 #2	US2_RX #5 CAN1_RX #1 US1_CS #2 U0_TX #5 LEU0_RX #3 I2C0_SCL #5	PRS_CH4 #2 DBG_SWDIOTMS GPIO_EM4WU3 BOOT_RX
PA1	BUSAY BUSBX LCD_SEG14	EBI_AD10 #0 EBI_DCLK #3	TIM0_CC0 #7 TIM0_CC1 #0 TIM3_CC1 #4 PCNT0_S1IN #4	ETH_RMIIRXD1 #0 ETH_MIITXD3 #0 SDIO_DAT1 #1 US3_RX #0 QSPI0_CS1 #1 I2C0_SCL #0	CMU_CLK1 #0 PRS_CH1 #0
PD12	LCD_SEG31	EBI_CS3 #0	TIM4_CC1 #6	ETH_RMIIRXER #1 SDIO_DAT4 #0 QSPI0_DQ3 #0 ETH_MIIRXCLK #2 US4_CS #1	
PD14		EBI_NANDWEn #1	TIM2_CDTI1 #1 TIM3_CC2 #6 WTIM0_CC2 #1	ETH_MDC #1 CAN0_RX #5 US4_RTS #1 US5_CS #1 I2C0_SDA #3	

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PB13	BUSAY BUSBX HFXTAL_P		TIM6_CC0 #5 WTIM1_CC0 #0 PCNT2_S0IN #2	US0_CLK #4 US1_CTS #5 US5_CS #0 LEU0_TX #1	CMU_CLKI0 #3 PRS_CH7 #0
PB14	BUSBY BUSAX HFXTAL_N		TIM6_CC1 #5 WTIM1_CC1 #0 PCNT2_S1IN #2	US0_CS #4 US1_RTS #5 US5_CTS #0 LEU0_RX #1	PRS_CH6 #1
PD1	VDAC0_OUT1ALT / OPA1_OUTALT #4 BUSADC0Y BU-SADC0X OPA3_OUT	EBI_A05 #1 EBI_A14 #3	TIM4_CDTI1 TIM0_CC0 #2 TIM6_CC0 #6 WTIM1_CC3 #0 PCNT2_S1IN #0	CAN0_TX #2 US1_RX #1	DBG_SWO #2
PD6	BUSADC0Y BU-SADC0X ADC0_EXTP VDAC0_EXT ADC1_EXTP OPA1_P	EBI_A10 #1 EBI_A19 #3	TIM1_CC0 #4 TIM6_CC2 #7 WTIM0_CDTI2 #4 WTIM1_CC0 #2 LE-TIM0_OUT0 #0 PCNT0_S0IN #3	US0_RTS #5 US1_RX #2 US2_CTS #5 US3_CTS #2 U0_RTS #5 I2C0_SDA #1	CMU_CLK2 #2 LES_ALTEX0 PRS_CH5 #2 ACMP0_O #2 ETM_TD0 #0

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
QSPI0_DQ7	0: PE11 1: PB6 2: PG8		Quad SPI 0 Data 7.
QSPI0_DQS	0: PF9 1: PE15 2: PG11		Quad SPI 0 Data S.
QSPI0_SCLK	0: PF6 1: PE14 2: PG0		Quad SPI 0 Serial Clock.
SDIO_CD	0: PF8 1: PC4 2: PA6 3: PB10		SDIO Card Detect.
SDIO_CLK	0: PE13 1: PE14		SDIO Serial Clock.
SDIO_CMD	0: PE12 1: PE15		SDIO Command.
SDIO_DAT0	0: PE11 1: PA0		SDIO Data 0.
SDIO_DAT1	0: PE10 1: PA1		SDIO Data 1.
SDIO_DAT2	0: PE9 1: PA2		SDIO Data 2.
SDIO_DAT3	0: PE8 1: PA3		SDIO Data 3.
SDIO_DAT4	0: PD12 1: PA4		SDIO Data 4.
SDIO_DAT5	0: PD11 1: PA5		SDIO Data 5.
SDIO_DAT6	0: PD10 1: PB3		SDIO Data 6.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
TIM2_CC1	0: PA9 1: PA13 2: PC9 3: PE12	4: PC0 5: PC3 6: PG9 7: PG6	Timer 2 Capture Compare input / output channel 1.
TIM2_CC2	0: PA10 1: PA14 2: PC10 3: PE13	4: PC1 5: PC4 6: PG10 7: PG7	Timer 2 Capture Compare input / output channel 2.
TIM2_CDTI0	0: PB0 1: PD13 2: PE8 3: PG0		Timer 2 Complimentary Dead Time Insertion channel 0.
TIM2_CDTI1	0: PB1 1: PD14 2: PE14 3: PG1		Timer 2 Complimentary Dead Time Insertion channel 1.
TIM2_CDTI2	0: PB2 1: PD15 2: PE15 3: PG2		Timer 2 Complimentary Dead Time Insertion channel 2.
TIM3_CC0	0: PE14 1: PE0 2: PE3 3: PE5	4: PA0 5: PA3 6: PA6 7: PD15	Timer 3 Capture Compare input / output channel 0.
TIM3_CC1	0: PE15 1: PE1 2: PE4 3: PE6	4: PA1 5: PA4 6: PD13 7: PB15	Timer 3 Capture Compare input / output channel 1.
TIM3_CC2	0: PA15 1: PE2 2: PE5 3: PE7	4: PA2 5: PA5 6: PD14 7: PB0	Timer 3 Capture Compare input / output channel 2.
TIM4_CC0	0: PF3 1: PF13 2: PF5 3: PI8	4: PF6 5: PF9 6: PD11 7: PE9	Timer 4 Capture Compare input / output channel 0.
TIM4_CC1	0: PF4 1: PF14 2: PI6 3: PI9	4: PF7 5: PD9 6: PD12 7: PE10	Timer 4 Capture Compare input / output channel 1.
TIM4_CC2	0: PF12 1: PF15 2: PI7 3: PI10	4: PF8 5: PD10 6: PE8 7: PE11	Timer 4 Capture Compare input / output channel 2.
TIM4_CDTI0	0: PD0		Timer 4 Complimentary Dead Time Insertion channel 0.
TIM4_CDTI1	0: PD1		Timer 4 Complimentary Dead Time Insertion channel 1.

Alternate Functionality	Location	Priority
US2_CLK	4: PF8 5: PF2	High Speed High Speed
US2_CS	4: PF9 5: PF5	High Speed High Speed
US2_RX	4: PF7 5: PF1	High Speed High Speed
US2_TX	4: PF6 5: PF0	High Speed High Speed

6.3 BGA192 Package Marking

Figure 6.3. BGA192 Package Marking

The package marking consists of:

- PPPPPPPPPP – The part number designation.
- TTTTTT – A trace or manufacturing code. The first letter is the device revision.
- YY – The last 2 digits of the assembly year.
- WW – The 2-digit workweek when the device was assembled.

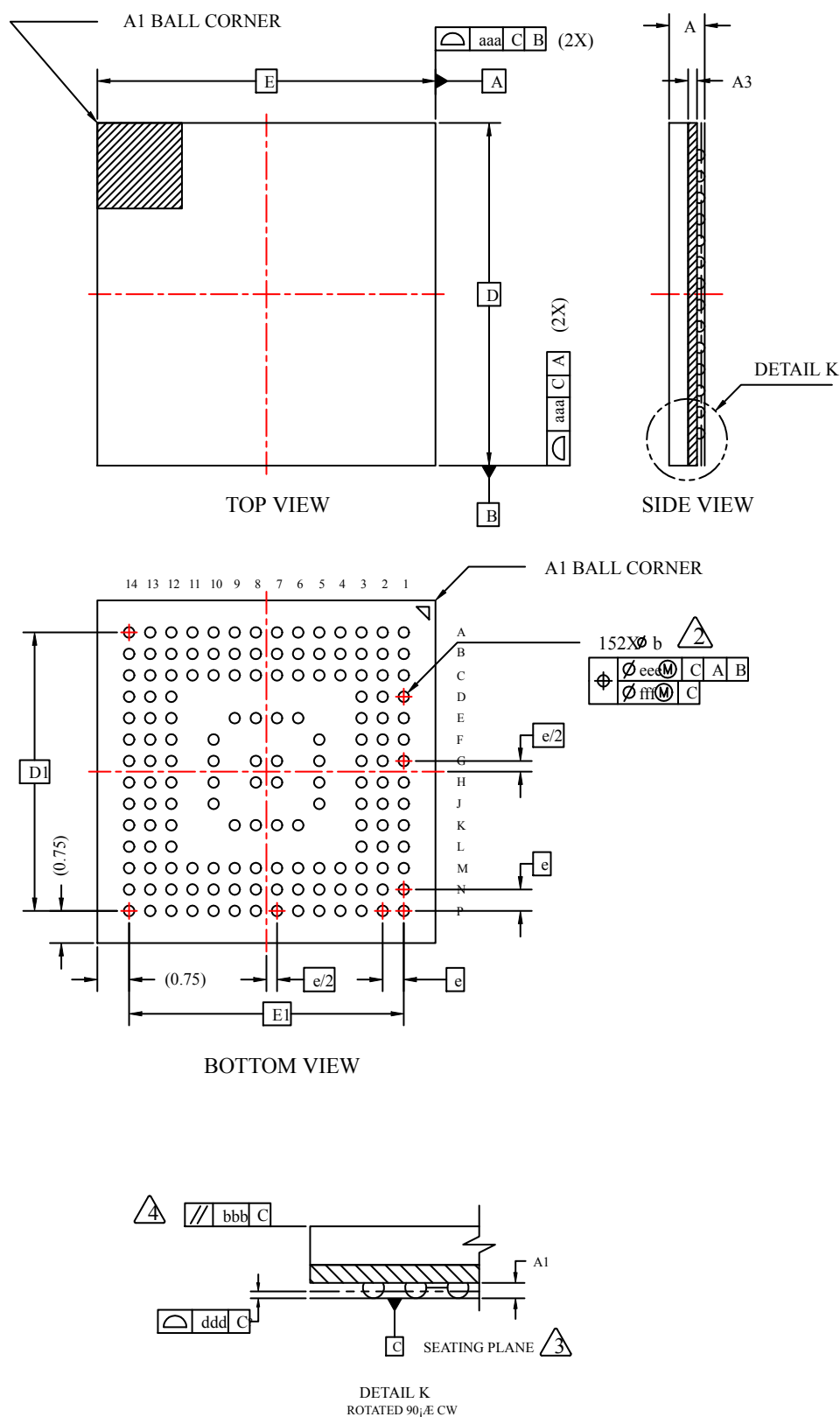# 7. BGA152 Package Specifications

7.1 BGA152 Package Dimensions

Figure 7.1. BGA152 Package Drawing

Table 8.1. BGA120 Package Dimensions

Dimension	Min	Typ	Max
A	0.78	0.84	0.90
A1	0.13	0.18	0.23
A3	0.17	0.21	0.25
A2		0.45 REF	
D		7.00 BSC	
e		0.50 BSC	
E		7.00 BSC	
D1		6.00 BSC	
E1		6.00 BSC	
b	0.20	0.25	0.30
aaa		0.10	
bbb		0.10	
ddd		0.08	
eee		0.15	
fff		0.05	

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.
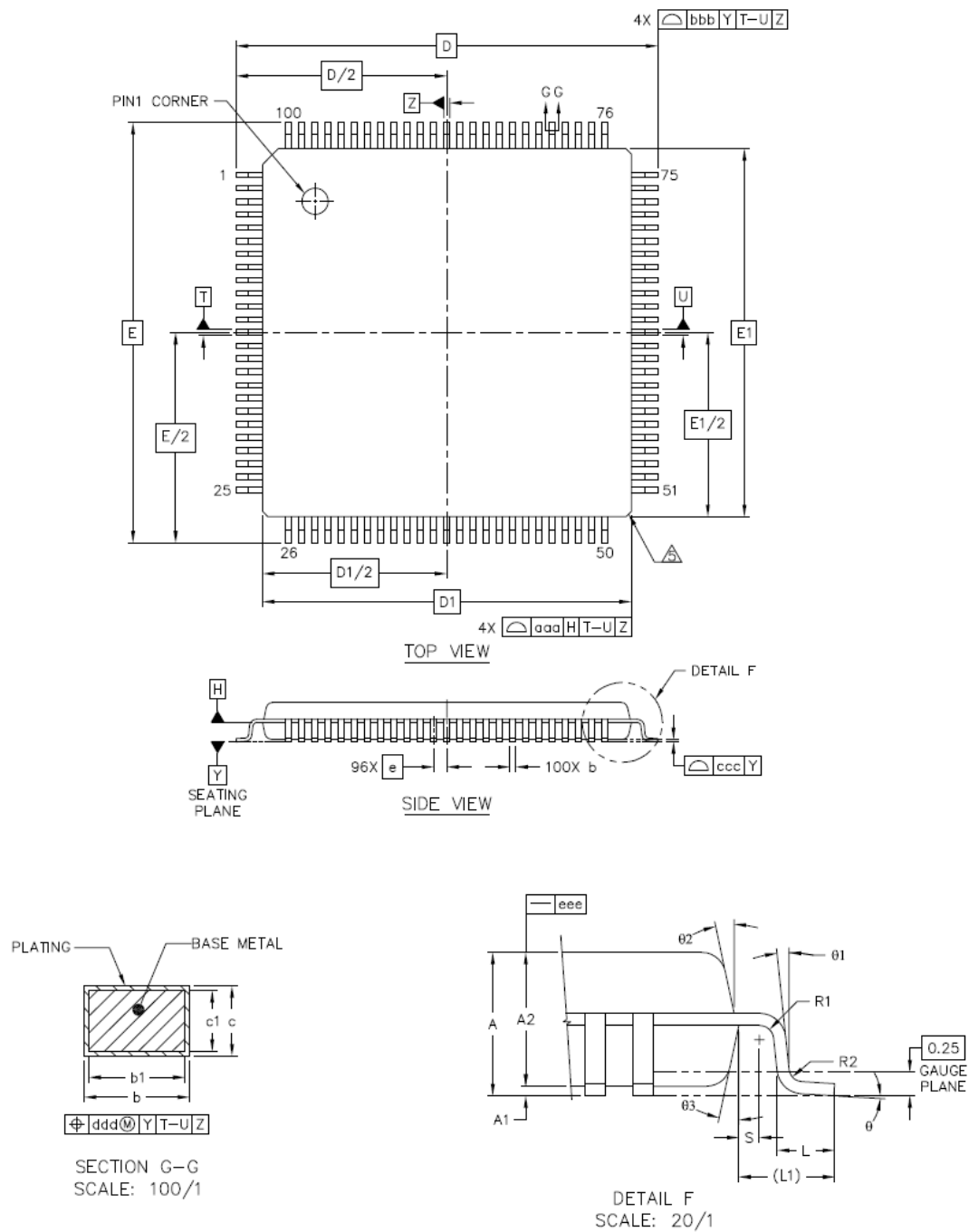
10. TQFP100 Package Specifications

10.1 TQFP100 Package Dimensions

Figure 10.1. TQFP100 Package Drawing